

P-Channel 100-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)	Q _g (Typ.)			
- 100	0.019 at V _{GS} = - 10 V	- 90	97 nC			
	0.021 at V _{GS} = - 4.5 V	- 85	97110			

FEATURES

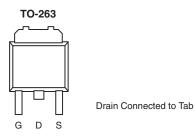
- TrenchFET[®] Power MOSFET
- Compliant to RoHS Directive 2002/95/EC

GC

s

P-Channel MOSFET





Top View

Ordering Information: SUM90P10-19L-E3 (Lead (Pb)-free)

ABSOLUTE MAXIMUM RATING	S T _A = 25 °C, unle	ss otherwise r	noted		
Parameter		Symbol	Limit	t Unit	
Drain-Source Voltage		V _{DS}	- 100	- V	
Gate-Source Voltage		V _{GS}	± 20		
	T _C = 25 °C		- 90		
Continuous Drain Current (T ₁ = 150 °C)	T _C = 125 °C	I _D	- 52	-	
	T _A = 25 °C		- 17.2 ^{b, c}	-	
	T _A = 125 °C		- 9.9 ^{b, c}	А	
Pulsed Drain Current		I _{DM}	- 90	1 ^	
Continuous Source-Drain Diode Current	T _C = 25 °C	I _S	- 250	-	
Continuous Source-Drain Diode Current	T _A = 25 °C		- 9 ^{b, c}		
Avalanche Current	L = 0.1 mH	I _{AS}	- 70		
Single-Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	245	mJ	
	T _C = 25 °C	P _D	375		
Movimum Dower Dissinction	T _C = 125 °C		125	w	
Maximum Power Dissipation	T _A = 25 °C	' D	13.6 ^{b, c}	1 **	
	T _A = 125 °C		4.5 ^{b, c}	1	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS						
Parameter	Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	8	11	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	0.33	0.4	0/11	

Notes:

a. Package Limited.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under Steady State conditions is 40 °C/W.



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = -250 \mu A$	- 100			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$			- 125			
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = - 250 μΑ		5.9		mV/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D =$ - 250 μ A	- 1		- 3	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zara Cata Valtaga Drain Current	la a a	$V_{DS} = -100 \text{ V}, V_{GS} = 0 \text{ V}$		- 1			
Zero Gate Voltage Drain Current	IDSS	V_{DS} = - 100 V, V_{GS} = 0 V, T_{J} = 175 °C			- 500	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge$ 10 V, V_{GS} = - 10 V	- 90			А	
	Б	$V_{GS} = -10$ V, $I_{D} = -20$ A		0.0156	0.019	0	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 15 A		0.0173	0.021	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 20 A		80		S	
Dynamic ^b	1 1		<u> </u>	<u> </u>			
Input Capacitance	C _{iss}			11100			
Output Capacitance	C _{oss}	V _{DS} = - 50 V, V _{GS} = 0 V, f = 1 MHz		700		- pF	
Reverse Transfer Capacitance	C _{rss}	$v_{\rm DS} = -30$ v, $v_{\rm GS} = 0$ v, $r = 1.0012$		1690			
		V_{DS} = - 50 V, V_{GS} = - 10 V, I_D = - 90 A		217	326		
Total Gate Charge	Qg			97	146	nC	
Gate-Source Charge	Q _{gs}	V_{DS} = - 50 V, V_{GS} = - 4.5 V, I_D = - 90 A		42			
Gate-Drain Charge	Q _{gd}			51			
Gate Resistance	Rg	f = 1 MHz		3.5		Ω	
Turn-On Delay Time	t _{d(on)}			20	30		
Rise Time	t _r	V_{DD} = - 50 V, R_L = 0.56 Ω		510	855	ns	
Turn-Off Delay Time	t _{d(off)}	${\rm I}_{\rm D}\cong$ - 90 A, ${\rm V}_{\rm GEN}$ = - 10 V, ${\rm R}_{\rm g}$ = 1 Ω		145	220		
Fall Time	t _f			870	1300		
Drain-Source Body Diode Characte	ristics						
Continous Source-Drain Diode Current	۱ _S	T _C = 25 °C			- 90	А	
Pulse Diode Forward Current ^a	I _{SM}				- 250		
Body Diode Voltage	V _{SD}	I _S = - 20 A		- 0.8	- 1.5	V	
Body Diode Reverse Recovery Time	t _{rr}			80	120	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = - 20 A, dl/dt = 100 A/μs, T _J = 25 °C		220	330	nC	
Reverse Recovery Fall Time	t _a			56			
Reverse Recovery Rise Time	t _b	-1 1		24		ns	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

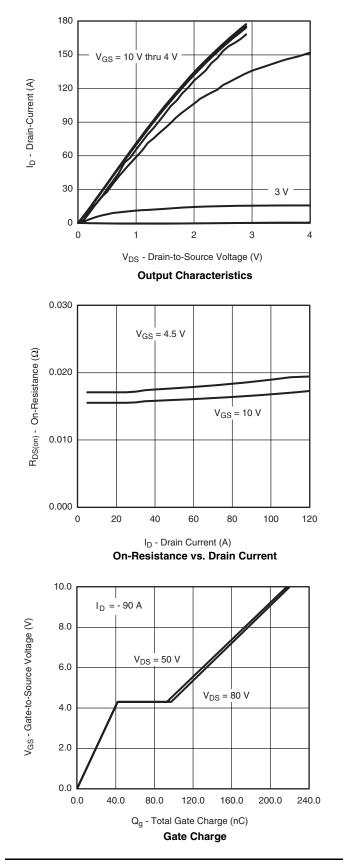
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

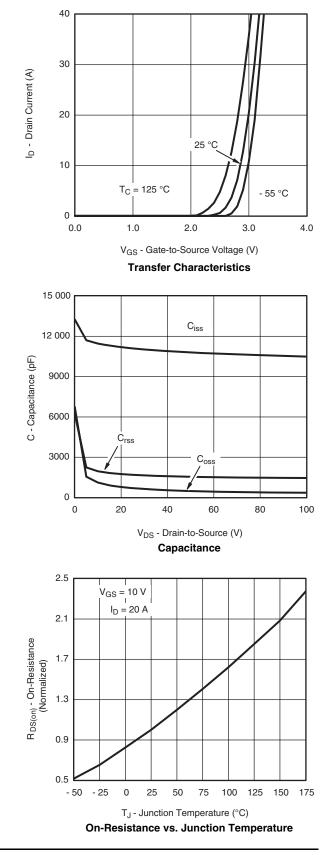


SUM90P10-19L

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

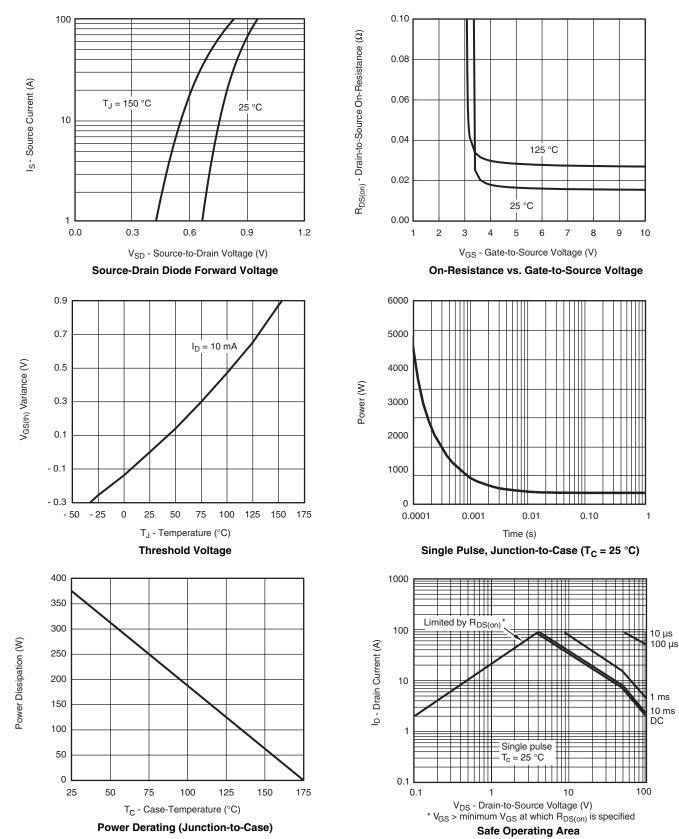


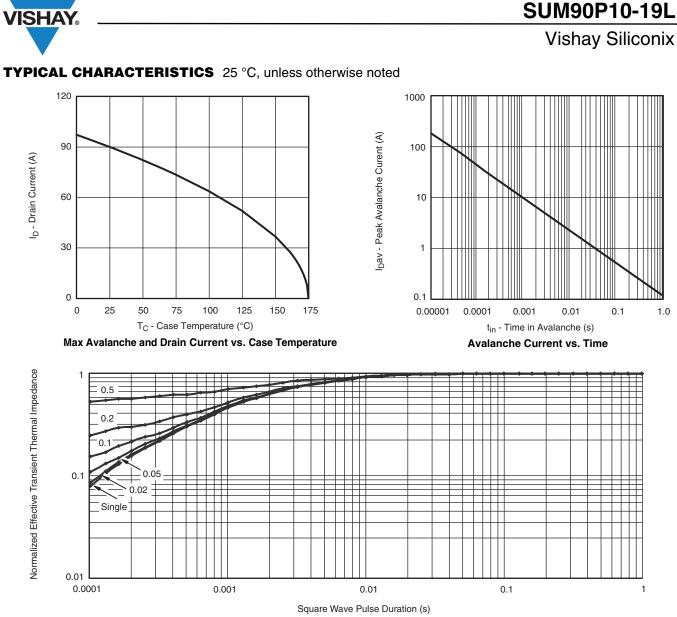


Document Number: 73474 S09-0659-Rev. E, 20-Apr-09



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





Normalized Thermal Transient Impedance, Junction-to-Case

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TO-263 (D²PAK): 3-LEAD









DETAIL A (ROTATED 90°)



		INCHES		MILLIMETERS		
DIM.		MIN.	MAX.	MIN.	MAX.	
A		0.160	0.190	4.064	4.826	
b		0.020	0.039	0.508	0.990	
	b1	0.020	0.035	0.508	0.889	
	b2	0.045	0.055	1.143	1.397	
с*	Thin lead	0.013	0.018	0.330	0.457	
C	Thick lead	0.023	0.028	0.584	0.711	
c1	Thin lead	0.013	0.017	0.330	0.431	
CI	Thick lead	0.023	0.027	0.584	0.685	
	c2	0.045	0.055	1.143	1.397	
	D	0.340	0.380	8.636	9.652	
	D1	0.220	0.240	5.588	6.096	
	D2	0.038	0.042	0.965	1.067	
	D3	0.045	0.055	1.143	1.397	
	D4	0.044	0.052	1.118	1.321	
	E	0.380	0.410	9.652	10.414	
E1		0.245	-	6.223	-	
E2		0.355	0.375	9.017	9.525	
E3		0.072	0.078	1.829	1.981	
	е	0.100	BSC	2.54	BSC	
К		0.045	0.055	1.143	1.397	
L		0.575	0.625	14.605	15.875	
L1		0.090	0.110	2.286	2.794	
L2		0.040	0.055	1.016	1.397	
L3		0.050	0.070	1.270	1.778	
L4		0.010) BSC	0.254	254 BSC	
	М	-	0.002	-	0.050	
ECN: T13-0707-Rev. K, 30-Sep-13 DWG: 5843						

Notes

- 1. Plane B includes maximum features of heat sink tab and plastic. 2. No more than 25 % of L1 can fall above seating plane by
- max. 8 mils.3. Pin-to-pin coplanarity max. 4 mils.
- 4. *: Thin lead is for SUB, SYB.
 - Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

This feature is for thick lead.

Revison: 30-Sep-13



RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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